506088983 06/03/2020

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6135701

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
HIROYOSHI KAWASAKI	05/07/2020
DAISUKE SOMA	05/07/2020

RECEIVING PARTY DATA

Name:	SENJU METAL INDUSTRY CO., LTD.
Street Address:	23, SENJU-HASHIDO-CHO, ADACHI-KU
City:	TOKYO
State/Country:	JAPAN
Postal Code:	120-8555

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16769426

CORRESPONDENCE DATA

Fax Number: (412)471-4094

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 412-471-8815

Email: assignments@webblaw.com
Correspondent Name: THE WEBB LAW FIRM, P.C.
Address Line 1: ONE GATEWAY CENTER

Address Line 2:420 FT. DUQUESNE BLVD, SUITE 1200Address Line 4:PITTSBURGH, PENNSYLVANIA 15222

ATTORNEY DOCKET NUMBER:	7466-1908043
NAME OF SUBMITTER:	BRYAN P. CLARK REG. #60465
SIGNATURE:	/Bryan P. Clark/
DATE SIGNED:	06/03/2020

Total Attachments: 3

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PATENT 506088983 REEL: 052826 FRAME: 0623

RECORDATION FORM COVER SHEET PATENTS ONLY	
	e record the attached documents or the new address(es) below.
1. Name of conveying party(ies) Hiroyoshi KAWASAKI Daisuke SOMA	2. Name and address of receiving party(ies) Name: Senju Metal Industry Co., Ltd. Internal Address:
Additional name(s) of conveying party(ies) attached? Yes No 3. Nature of conveyance/Execution Date(s): Execution Date(s) May 7, 2020 Assignment Merger Security Agreement Change of Name Joint Research Agreement Government Interest Assignment Executive Order 9424, Confirmatory License Other 4. Application or patent number(s): This A. Patent Application No.(s) 16/769,426	Street Address: 23, Senju-Hashido-cho, Adachi-ku City: Tokyo State: Country: JAPAN
Additional numbers att	ached? Yes No
5. Name and address to whom correspondence concerning document should be mailed: Name: Bryan P. Clark Internal Address: The Webb Law Firm	6. Total number of applications and patents involved: 1 7. Total fee (37 CFR 1.21(h) & 3.41) \$0 Authorized to be charged to deposit account
Street Address: One Gateway Center 420 Ft. Duquesne Blvd., Ste 1200	Enclosed None required (government interest not affecting title)
City: Pittsburgh	8. Payment Information
State: PA Zi p: 15222	
Phone Number: 412-471-8815 Docket Number: 7466 - 1908043 Email Address: assignments@webblaw.com	Deposit Account NumberAuthorized User Name
9. Signature: /Bryan P. Clark/	June 3, 2020
Signature Bryan P. Clark Name of Person Signing Documents to be recorded (including cover sheet	Total number of pages including cover sheet, attachments, and documents: 3 should be faxed to (571) 273-0140, or mailed to: the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450

PATENT REEL: 052826 FRAME: 0624

IN.	TERNATIONAL
Application N	3
Attorney Docket No.	7466-1908043

ASSIGNMENT

900000000000000000000000000000000000000
WHEREAS, as a below named inventor, I have invented certain new and useful improvements in Cu BALL OSP-TREATED CU BALL, CU CORE BALL, SOLDER JOINT, SOLDER PASTE, FORMED SOLDER, AND HETHOD FOR HANGEACTURING CU BALL (Invention Title)
for which I have this day executed an application for a United States Patent (hereinafter "said application"). AND/OR
for which an application for a United States Patent was filed on(mm/dd/yyyy) and bears Application Number (hereinafter "said application"). AND/OR
for which an international patent application was filed under the Patent Cooperation Treaty on (num/dd/yyyy), bearing Application No. (hereinafter "said application").
AND, WHEREAS, Senju Metal Industry Co., Ltd., a corporation of Japan, having a place of business at 23, Senju-Hashido-cho, Adachi-ku, Tokyo 120-8555, Japan, hereinafter called the "assignee", is desirous of acquiring the entire right, title, and interest in and to said application and the inventions and improvements therein disclosed.
NOW, THEREFORE, for good and valuable consideration paid to me by said assignee, the receipt of which is hereby acknowledged, I as the inventor or as one of the inventors, hereinafter the assignor(s), do hereby assign, sell and transfer unto said assignee the full and exclusive right, title and interest in and to said application and the inventions and improvements therein disclosed for the United States and all foreign countries, including rights of priority under the International Convention of Paris (1883) as amended, and any Letters Patent which may issue therefor in the United States and all foreign countries and all divisions, reissues, continuations, continuations-in-part, renewals and/or extensions thereof. Such assignment extends to the full ends of the terms of these applications and patents as fully and entirely as the same would have been held and enjoyed by me had this Assignment not been made.
I hereby authorize and request any attorney associated with The Webb Law Firm, Customer No. 28289, to insert here in parentheses (Application No. $\frac{16/769,426}{\text{filled} \frac{12/04/2018}{\text{o}}}$) the filing date and application number of said application when known.
I covenant that I am the lawful owner(s) of said application, inventions and improvements, that the same are unencumbered, that no license has been granted to make, use or vend the said inventions or improvements or any of them, and that I have the full right to make this Assignment.

	INTERNATIONAL
Application	No
Attorney Docket No	. 7466-1908043

And for the consideration aforesaid, I agree individually and, if applicable, jointly that I will communicate to said assignee or the representatives thereof any facts known to me respecting said inventions and improvements, and will, upon request but without expense to me, testify in any legal proceedings, sign all lawful papers, execute all divisional, reissue, continuation, continuation-in-part, renewal and/or extension applications, make all rightful oaths, and generally do all other and further lawful acts deemed necessary or expedient by said assignee or by counsel for said assignee to assist or enable said assignee to obtain and enforce full benefits from the rights and interests herein assigned. This Assignment shall be binding upon my heirs, executors, administrators and/or assigns, and shall inure to the benefit of the heirs, executors, administrators, successors and/or assigns, as the case may be, of said assignee.

FULL NAME OF ASSIGNOR: Hiroyoshi KAWASAKI	RESIDENCE: Tokyo, Japan
EXECUTED this 7th day of May	
WITNESS:	
	······································
2. FULL NAME OF ASSIGNOR: Daisuke SOMA	RESIDENCE: Tochigi, Japan
EXECUTED this 74h day of Ma	, 201920 Doisuke SOMA SIGNATURE
WITNESS:	
Checked Box indicates additio	nal page(s) for inventor signatures.
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RECORDED: 06/03/2020